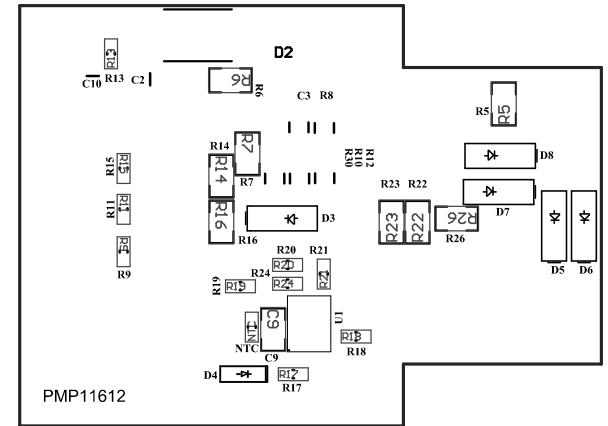


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| PCB VIEWED FROM TOP SIDE | BOARD #: PMP11612 | REV: A | SVN REV: Not In VersionControl |
| Top Overlay | TID #: PMP11612 | | |
| PLOT NAME = Top Assembly Drawing | GENERATED : 3/31/2016 6:32:02 PM | TEXAS INSTRUMENTS | |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

| | | | |
|-------------------------------------|-----------------------|----------------|--------------------------------|
| PCB VIEWED FROM BOTTOM SIDE | BOARD #: PMP11612 | REV: A | SUN REV: Not In VersionControl |
| | TID #: PMP11612 | Bottom Overlay | |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 3/31/2016 | 6:32:03 PM | TEXAS INSTRUMENTS |

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